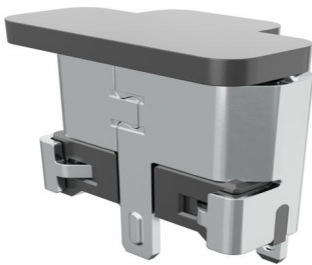




Part Number : [1051330002](#)
Product Description : Micro-USB B Receptacle,
Vertical, Surface Mount, 6.70mm Height, 1.70mm
Solder Tabs, with Cover, Lead-Free
Series Number : 105133
Status : Active
Product Category : I/O Connectors



Documents and Resources

Drawings

[1051330002_sd.pdf](#)
[PK-105133-001-001.pdf](#)

3D Models and Design Files

[STEP AP242](#)
[SOLIDWORKS](#)
[Creo](#)

Specifications

[PS-105133-001-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)
EU RoHS	Compliant per EU 2015/863

[Compliance Statements](#)

- EU RoHS
- REACH SVHC

- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	I/O Connectors
Series	105133
Description	Micro-USB B Receptacle, Vertical, Surface Mount, 6.70mm Height, 1.70mm Solder Tabs, with Cover, Lead-Free
Application	Wire-to-Board
Comments	Signal contacts 1.0A, Power contacts 1.8A
Component Type	Receptacle
Product Name	USB
Standard	USB 2.0
Type	Micro-B
UPC	884982862722

Agency

UL	E107635
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Electrical

Current - Maximum per Contact	1.8A, 1.0A
Grounding to Panel	Yes
Shielded	Yes

Shield Type	Full Shield
Voltage - Maximum	30V AC (RMS)

Physical

Circuits (Loaded)	5
Circuits (maximum)	5
Color - Resin	Black
Durability (mating cycles max)	10000
Flammability	94V-0
Gender	Female
Keying to Mating Part	Yes
Lock to Mating Part	No
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Gold
Material - Resin	High Temperature Thermoplastic
Mounting Style	Vertical
Net Weight	0.358/g
Number of Rows	1
Orientation	Vertical
Packaging Type	Embossed Tape on Reel
Panel Mount	No
PCB Retention	No
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	0.65mm
Pitch - Termination Interface	0.65mm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	1
Temperature Range - Operating	-30° to +85°C
Termination Interface Style	Surface Mount
Waterproof / Dustproof	No

Solder Process Data

Max-Duration	2
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Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	255

This document was generated on Jun 02, 2026